

[06 – Systems, Subsystems and Equipment]

## 5.2 \_ Thermal Modeling

<b>Date</b>	26 September 2016 (Monday)
<b>Time</b>	13:00–14:30
<b>Place</b>	Track 5 (#105)
<b>Session Chair: Y. Fu</b>	

<b>5.2.1</b>	<b>13:00–13:30</b>	<b>[2016_0554] SPECIAL CONSIDERATIONS TO THERMAL BEHAVIOR MODELING AND SIMULATION OF AN AEROSPACE ELECTROMECHANICAL ACTUATION SYSTEM</b> J. Fu <sup>1</sup> , Y. Fu <sup>1</sup> , J.-C. Mare, Institut Clément Ader, INSA-Toulouse, France; <sup>1</sup> Beihang University, China
<b>5.2.2</b>	<b>13:30–14:00</b>	<b>[2016_0105] COUPLED EMC-THERMAL MODELING OF ELECTRICAL HARNESSSES WITHIN "MORE ELECTRICAL AIRCRAFT"</b> F. Mahiddini <sup>1</sup> , M. Ride <sup>1</sup> , P. Reulet <sup>1</sup> , D. Donjat <sup>1</sup> , P. Millan <sup>1</sup> ; <sup>1</sup> ONERA, France